

SN54AC374, SN74AC374 OCTAL D-TYPE EDGE-TRIGGERED FLIP-FLOPS WITH 3-STATE OUTPUTS

SCAS543B – OCTOBER 1995 - REVISED JUNE 1996

- 3-State Noninverting Outputs Drive Bus Lines Directly
- Full Parallel Access for Loading
- **EPIC™** (Enhanced-Performance Implanted CMOS) 1-μm Process
- Package Options Include Plastic Small-Outline (DW) Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK) and Flatpacks (W), and Standard Plastic (N) and Ceramic (J) DIPs

description

These 8-bit flip-flops feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. The devices are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

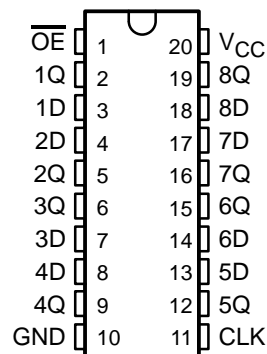
The eight flip-flops of the 'AC374 are D-type edge-triggered flip-flops. On the positive transition of the clock (CLK) input, the Q outputs are set to the logic levels set up at the data (D) inputs.

A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines in bus-organized systems without need for interface or pullup components.

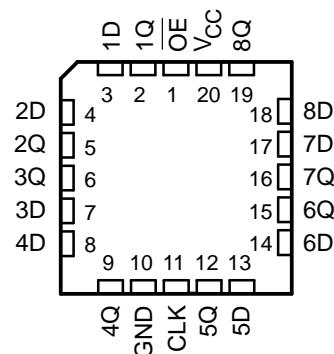
\overline{OE} does not affect internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The SN54AC374 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74AC374 is characterized for operation from -40°C to 85°C .

SN54AC374 . . . J OR W PACKAGE
SN74AC374 . . . DB, DW, N, OR PW PACKAGE
(TOP VIEW)



SN54AC374 . . . FK PACKAGE
(TOP VIEW)



FUNCTION TABLE
(each flip-flop)

INPUTS			OUTPUT Q
\overline{OE}	CLK	D	
L	\uparrow	H	H
L	\uparrow	L	L
L	H or L	X	Q_0
H	X	X	Z



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**TEXAS
INSTRUMENTS**

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To Seven Other Channels

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils, except for the N package, which has a trace length of zero.

SN54AC374, SN74AC374

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WITH 3-STATE OUTPUTS

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recommended operating conditions (see Note 3)

			SN54AC374		SN74AC374		UNIT
			MIN	MAX	MIN	MAX	
V _{CC}	Supply voltage		2	6	2	6	V
V _{IH}	High-level input voltage	V _{CC} = 3 V	2.1		2.1		V
		V _{CC} = 4.5 V	3.15		3.15		
		V _{CC} = 5.5 V	3.85		3.85		
V _{IL}	Low-level input voltage	V _{CC} = 3 V		0.9		0.9	V
		V _{CC} = 4.5 V		1.35		1.35	
		V _{CC} = 5.5 V		1.65		1.65	
V _I	Input voltage		0	V _{CC}	0	V _{CC}	V
V _O	Output voltage		0	V _{CC}	0	V _{CC}	V
I _{OH}	High-level output current	V _{CC} = 3 V		-12		-12	mA
		V _{CC} = 4.5 V		-24		-24	
		V _{CC} = 5.5 V		-24		-24	
I _{OL}	Low-level output current	V _{CC} = 3 V		12		12	mA
		V _{CC} = 4.5 V		24		24	
		V _{CC} = 5.5 V		24		24	
Δt/Δv	Input transition rise or fall rate		0	8	0	8	ns/V
T _A	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			SN54AC374		SN74AC374		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V _{OH}	I _{OH} = -50 μA	3 V	2.9			2.9		2.9		V
		4.5 V	4.4			4.4		4.4		
		5.5 V	5.4			5.4		5.4		
	I _{OH} = -12 mA	3 V	2.56			2.4		2.46		
		4.5 V	3.86			3.7		3.76		
		5.5 V	4.86			4.7		4.76		
V _{OL}	I _{OL} = 50 μA	3 V			0.1		0.1		0.1	V
		4.5 V			0.1		0.1		0.1	
		5.5 V			0.1		0.1		0.1	
	I _{OL} = 12 mA	3 V			0.36		0.5		0.44	
		4.5 V			0.36		0.5		0.44	
		5.5 V			0.36		0.5		0.44	
I _I	V _I = V _{CC} or GND	5.5 V			±0.1		±1		±1	μA
I _{OZ}	V _O = V _{CC} or GND	5.5 V			±0.25		±5		±2.5	μA
I _{CC}	V _I = V _{CC} or GND, I _O = 0	5.5 V			4		80		40	μA
C _i	V _I = V _{CC} or GND	5 V		4.5						pF



SN54AC374, SN74AC374

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timing requirements over recommended operating free-air temperature range, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

		$T_A = 25^\circ\text{C}$		SN54AC374		SN74AC374		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
t_W	Pulse duration, CLK high or low	5.5		6.5		6		ns
t_{SU}	Setup time, data before CLK \uparrow	5.5		6.5		6		ns
t_H	Hold time, data after CLK \uparrow	1		1		1		ns

timing requirements over recommended operating free-air temperature range, $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

		$T_A = 25^\circ\text{C}$		SN54AC374		SN74AC374		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
t_W	Pulse duration, CLK high or low	4		5		4.5		ns
t_{SU}	Setup time, data before CLK \uparrow	4		5		4.5		ns
t_H	Hold time, data after CLK \uparrow	1.5		1.5		1.5		ns

switching characteristics over recommended operating free-air temperature range, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	TO (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			SN54AC374		SN74AC374		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}			60	110		60		60		MHz
t_{PLH}	CLK	Q	3	11	13.5	3	16.5	1.5	15.5	ns
t_{PHL}			2.5	10	12.5	3	15	2	14	
t_{PZH}	\overline{OE}	Q	3	9.5	11.5	1	14	1.5	13	ns
t_{PZL}			3.5	9	11.5	1	14	1.5	13	
t_{PHZ}	\overline{OE}	Q	3	10.5	12.5	1	16	2	14.5	ns
t_{PLZ}			2	8	11.5	1	13	1	12.5	

switching characteristics over recommended operating free-air temperature range, $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	TO (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			SN54AC374		SN74AC374		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}			100	155		95		100		MHz
t_{PLH}	CLK	Q	2.5	8	9.5	3	12	1.5	10.5	ns
t_{PHL}			2	7	9	3	11	1.5	10	
t_{PZH}	\overline{OE}	Q	2	7	8.5	1.5	10	1	9.5	ns
t_{PZL}			2	6.5	8.5	1.5	10.5	1	9.5	
t_{PHZ}	\overline{OE}	Q	2	8	11	1.5	12.5	2	12.5	ns
t_{PLZ}			1.5	6.5	8.5	1.5	10.5	1	10	

operating characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C_{pd} Power dissipation capacitance	$C_L = 50\text{ pF}$, $f = 1\text{ MHz}$	40	pF

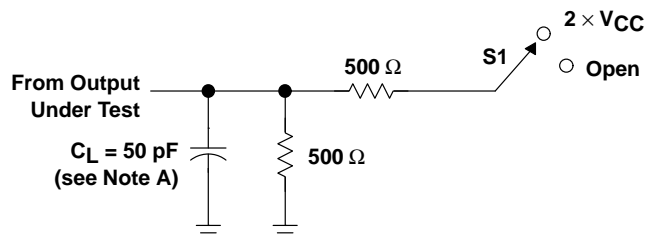


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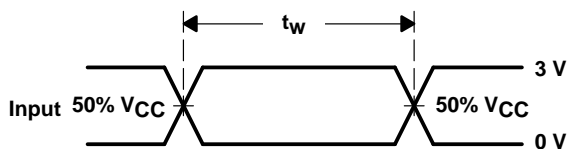
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PARAMETER MEASUREMENT INFORMATION

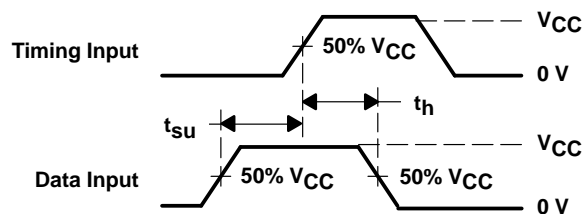


LOAD CIRCUIT

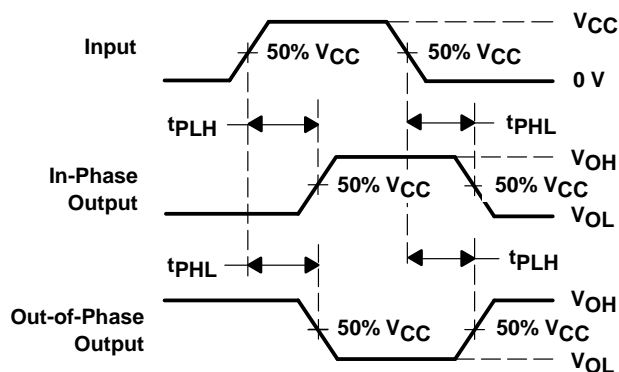
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	$2 \times V_{CC}$
t_{PHZ}/t_{PZH}	Open



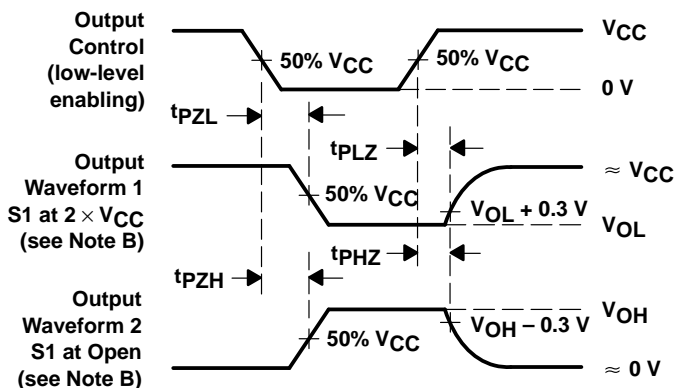
VOLTAGE WAVEFORMS



VOLTAGE WAVEFORMS



VOLTAGE WAVEFORMS



VOLTAGE WAVEFORMS

- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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